

**PATENT ASSIGNMENT**

Electronic Version v1.1  
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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT								
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT								
<b>CONVEYING PARTY DATA</b>									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Toshihiro TAI</td> <td>06/30/2006</td> </tr> <tr> <td>Weihong GU</td> <td>06/30/2006</td> </tr> <tr> <td>Tatsuo IZUMITANI</td> <td>06/30/2006</td> </tr> </tbody> </table>		Name	Execution Date	Toshihiro TAI	06/30/2006	Weihong GU	06/30/2006	Tatsuo IZUMITANI	06/30/2006
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<table border="1" style="width:100%; border-collapse: collapse;"> <tr> <td style="width:20%;"><b>Name:</b></td> <td>Daicel Polymer Ltd.</td> </tr> <tr> <td><b>Street Address:</b></td> <td>2-18-1, Konan, Minato-ku</td> </tr> <tr> <td><b>City:</b></td> <td>Tokyo</td> </tr> <tr> <td><b>State/Country:</b></td> <td>JAPAN</td> </tr> </table>		<b>Name:</b>	Daicel Polymer Ltd.	<b>Street Address:</b>	2-18-1, Konan, Minato-ku	<b>City:</b>	Tokyo	<b>State/Country:</b>	JAPAN
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<b>Street Address:</b>	1, Teppo-cho, Sakai-ku, Sakai-shi								
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<b>PROPERTY NUMBERS Total: 1</b>									
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<b>CORRESPONDENCE DATA</b>									
Fax Number: (269)381-5465 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 269-381-1156 Email: docket@flynnthiel.com Correspondent Name: Terryence F. Chapman Address Line 1: 2026 Rambling Road Address Line 4: Kalamazoo, MICHIGAN 49008									
<b>ATTORNEY DOCKET NUMBER:</b>	3400.P1434US								

CH \$40.00 10586378

NAME OF SUBMITTER:

Terryence F. Chapman

Total Attachments: 1

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ASSIGNMENT

United States (Sole or Joint)  
(Excluding Foreign Rights)

WHEREAS, I/We, (1) Toshihiro TAI (2) Weihong GU and (3) Tatsuo IZUMITANI

residing at (1) c/o Daicel Polymer Ltd., R&D Group, 1, Teppo-cho, Sakai-ku, Sakai-shi, Osaka, Japan (2) c/o Daicel Chemical Industries, Ltd., Research Park, 1239, Shinzaike, Aboshi-ku, Himeji-shi, Hyogo, Japan and (3) c/o Daicel Chemical Industries, Ltd., Research Park, 1239, Shinzaike, Aboshi-ku, Himeji-shi, Hyogo, Japan

have invented certain new and useful improvements in  
PLATED RESIN MOLDED ARTICLES

for which an application for United States Letters patent was signed by us on even date herewith.

WHEREAS, (1) Daicel Polymer Ltd. and (2) Daicel Chemical Industries, Ltd.

having a place of business at (1) 2-18-1, Konan, Minato-ku, Tokyo, Japan and (2) 1, Teppo-cho, Sakai-ku, Sakai-shi, Osaka, Japan

hereinafter called the "Assignee", is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefor, in the United States and its territorial possessions.

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other valuable considerations, the receipt whereof is hereby acknowledged, I/we have sold, assigned and transferred, and by these presents do sell, assign, transfer and confirm in and to said Assignee my/our full and exclusive right to the said invention in the United States and its territorial possessions and my/our entire right, title and interest in and to said application and any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in and to any and all divisions, reissues, continuations and extensions thereof.

I/We hereby authorize and request the Patent Office Officials in the United States to issue any and all of said Letters Patent, when granted, to said Assignee for the sole use and behoof of the said Assignee, its successors and assigns.

IN TESTIMONY WHEREOF, I/we have hereunto set my/our hand(s).

Witnessed by:

Inventor(s):

Date:

\_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_

Toshihiro Tai June 30, 2006  
Toshihiro TAI  
Weihong Gu June 30, 2006  
Weihong GU  
Tatsuo Izumitani June 30, 2006  
Tatsuo IZUMITANI

PATENT